

Mатеринские платы Intel® Краткие спецификации





DP67BG





Processor (LGA 1155) 95W+FMB	 Supports Intel® Core™ i7 and Core™ i5 processor in the LGA 1155 package
Chipset	 Intel® P67 Express Chipset Intel® Matrix Storage Manager RAID 0,1,5,10 with Intel® Rapid Recover Technology & Matrix RAID
Метогу	Dual channel DDR3 1600/1333/1066 MHzXMP Supports overclocking beyond 1333 MHz4 DIMMs, 16 GB maximum
Graphics	 1 PCI Express*2.0 x16 Graphics Slot or switchable to 2x8 PCIe 2.0 Supports ATI* Crossfire and NVIDIA* SLI
Expandability	 7 SATA ports, 4 (3.0 Gb/s), 2 (6.0Gb/s) internal connectors, 1 eSATA via external port) 2 IEEE 1394a ports (1 external port, 1 via internal header) 14 USB 2.0 ports (8 external ports, 6 via internal headers) 2 USB 3.0 ports (2 external ports) 3 PCIe x1, 2 PCI
Audio	 8 channel rear I/O, 2 internal header; Intel® High Definition Audio 6 stack analog audio ports w/ optical S/PDIF out and SPDIF Hdr Front panel mic/headphone header
Connectivity	■ Intel® 10 / 100 / 1000 Network Connection
Additional Features	 Windows WHQL certified Consumer Infrared receiver and emitter (Vista* MCE compliant) Back-to-BIOS switch On Board LED post decoder
Customer Transition	Follow on to DP55KG/WG
Form Factor	- ATX (9.6" x 12")



DP67BA





Processor Support(H2) LGA 1155, 95W FMB Chipset	 Supports the Intel® Core™ i7, Intel® Core™ i5 and Intel® Core™ i3 processors in the LGA1155 package Supports Intel® Turbo Boost Technology Supports Intel® Hyper-Threading Technology Intel® P67 Express Chipset Intel® Rapid Storage Technology, supports RAID 0,1,5,10 Dual channel DDR3 1333/1066 MHz 4 DIMMs, 32 GB maximum
Graphics	1 PCI Express*2.0 x16 Graphics Slot
Expandability	 4 SATA ports (3.0 Gb/s, 2 ports compatible with eSATA for back panel extension, 1 external eSATA) 2 SATA port (6.0 Gb/s) 2 IEEE 1394a ports (1 external port, 1 via internal header) 2 PCIe x1 14 USB 2.0 ports (6 external ports, 8 via internal headers) 2 USB 3.0 back panel ports
Audio	 5 stack analog audio ports Rear optical S/PDIF out port and SPDIF out header Front panel mic/headphone header
Connectivity	■ Intel® 10 / 100 / 1000 Network Connection
Additional Features	 Windows Vista Premium WHQL certified Consumer Infrared receiver and emitter (Vista* MCE compliant)
Customer Transition	DP55WB (ATX Version)
Form Factor	■ ATX (9.6" x 11.6")

^{1.} Intel® Turbo Boost Technology requires a PC with a processor with Intel Turbo Boost Technology capability. Intel Turbo Boost Technology performance varies depending on hardware, software, and overall system configuration. Check with your PC manufacturer on whether your system delivers Intel Turbo Boost Technology. See www.intel.com/technology/turboboost for more information.

2. Intel® Hyper-Threading Technology requires a computer system with a processor supporting HT Technology and an HT Technology-enabled chipset, BIOS, and operating system. Performance will vary depending on the specific hardware and software you use. For more information including details on which processors support HT Technology, see www.intel.com/info/hyperthreading.



DZ68DB





Processor Support(H2) LGA 1155, 95W FMB Chipset	 Supports the Intel® Core™ i7, Intel® Core™ i5 and Intel® Core™ i3 processors in the LGA1155 package Supports Intel® Turbo Boost Technologyπ Supports Intel® Hyper-Threading Technology Intel® Z68 Express Chipset Intel® Smart Response Technology
	Intel® Rapid Storage Technology, supports RAID 0,1,5,10
Memory	 Dual channel DDR3 1333/1066 MHz 4 DIMMs, 32GB maximum 1.2V-1.8V Memory voltage control for maximum DIMM compatibility
Graphics	1 PCI Express*2.0 x16 Graphics SlotDVI-I+HDMI+DisplayPort(DP) display output
Expandability	 3 SATA ports (3.0 Gb/s, 1 port is compatible with eSATA for back panel extension) 2 SATA port (6.0 Gb/s) 1 eSATA back panel port(3.0 Gb/s) 2 IEEE 1394a ports (1 back panel port and 1 via internal header) 2 USB 3.0 back panel ports 14 USB 2.0 ports (6 external ports, 8 via internal headers) 2 PCI Express*2.0 x1 slots 1 PCI slot
Audio	 10 (7.1+2) channel Intel® High Definition Audio 5 stack analog audio ports Rear optical S/PDIF out port and SPDIF out header Front panel mic/headphone header Internal speaker header
Connectivity	■ Intel® PRO 10/100/1000 integrated NIC
Additional Features	Windows Vista* Premium WHQL certifiedWindows 7 WHQL certifiedConsumer Infrared receiver and emitter
Form Factor	• ATX (9.6" x 11.6")

^{1.} Intel® Turbo Boost Technology requires a PC with a processor with Intel Turbo Boost Technology capability. Intel Turbo Boost Technology performance varies depending on hardware, software, and overall system configuration. Check with your PC manufacturer on whether your system delivers Intel Turbo Boost Technology. See www.intel.com/technology/turboboost for more information.

2. Intel® Hyper-Threading Technology requires a computer system with a processor supporting HT Technology and an HT Technology-enabled chipset, BIOS, and operating system. Performance will vary depending on the specific hardware and software you use. For more information including details on which processors support HT Technology, see www.intel.com/info/hyperthreading.



DH67GD





Processor Support(H2) LGA 1155,95W FMB	 Supports the Intel® Core™ i7, Intel® Core™ i5 and Intel® Core™ i3 processors in the LGA1155 package Supports Intel® Turbo Boost Technologyπ Supports Intel® Hyper-Threading Technology
Chipset	 Intel® H67 Express Chipset Intel® Rapid Storage Technology, supports RAID 0,1,5,10
Memory	 Dual channel DDR3 1333/1066 MHz 4 DIMMs, 16 GB maximum 1.2V-1.8V Memory voltage control for maximum DIMM compatibility
Graphics	1 PCI Express*2.0 x16 Graphics SlotDVI-I+HDMI+DisplayPort(DP) display output
Expandability	 3 SATA ports (3.0 Gb/s, 1 port is compatible with eSATA for back panel extension) 2 SATA port (6.0 Gb/s) 1 eSATA back panel port(3.0 Gb/s) 2 IEEE 1394a ports (1 back panel port and 1 via internal header) 2 USB 3.0 back panel ports 14 USB 2.0 ports (6 external ports, 8 via internal headers) 2 PCI Express*2.0 x1 slots 1 PCI slot
Audio	 10 (7.1+2) channel Intel® High Definition Audio 5 stack analog audio ports Rear optical S/PDIF out port and SPDIF out header Front panel mic/headphone header Internal speaker header
Connectivity	■ Intel® PRO 10/100/1000 integrated NIC
Additional Features	Windows Vista* Premium WHQL certifiedWindows 7 WHQL certifiedConsumer Infrared receiver and emitter
Form Factor	■ MicroATX (9.6" x 9.6")

^{1.} Intel® Turbo Boost Technology requires a PC with a processor with Intel Turbo Boost Technology capability. Intel Turbo Boost Technology performance varies depending on hardware, software, and overall system configuration. Check with your PC manufacturer on whether your system delivers Intel Turbo Boost Technology. See www.intel.com/technology/turboboost for more information.

2. Intel® Hyper-Threading Technology requires a computer system with a processor supporting HT Technology and an HT Technology, enabled chipset, BIOS, and operating system. Performance will vary depending on the specific hardware and software you use. For more information including details on which processors support HT Technology, see www.intel.com/info/hyperthreading.



DH67CL





Processor Support(H2) LGA 1155, 95W FMB	 Supports the Intel® Core™ i7, Intel® Core™ i5 and Intel® Core™ i3 processors in the LGA1155 package Supports Intel® Turbo Boost Technologyπ Supports Intel® Hyper-Threading Technology
Chipset	 Intel® H67 Express Chipset Intel® Rapid Storage Technology, supports RAID 0,1,5,10
Memory	 Dual channel DDR3 1333/1066 MHz 4 DIMMs, 16 GB maximum 1.2V-1.8V Memory voltage control for maximum DIMM compatibility
Graphics	1 PCI Express*2.0 x16 Graphics SlotDVI-I+HDMI display output
Expandability	 3 SATA ports (3.0 Gb/s, 1 port is compatible with eSATA for back panel extension) 2 SATA port (6.0 Gb/s) 1 eSATA back panel port(3.0 Gb/s) 2 USB 3.0 back panel ports 14 USB 2.0 ports (6 external ports, 8 via internal headers) 2 PCI Express*2.0 x1 slots 3 PCI slot
Audio	 10 (7.1+2) channel Intel® High Definition Audio 5 stack analog audio ports Rear optical S/PDIF out port and SPDIF out header Front panel mic/headphone header Internal speaker header
Connectivity	■ Intel® PRO 10/100/1000 integrated NIC
Additional Features	 Windows Vista* Premium WHQL certified Windows 7 WHQL certified Consumer Infrared receiver and emitter
Form Factor	■ ATX (9.6" x 11.6")

^{1.} Intel® Turbo Boost Technology requires a PC with a processor with Intel Turbo Boost Technology capability. Intel Turbo Boost Technology performance varies depending on hardware, software, and overall system configuration. Check with your PC manufacturer on whether your system delivers Intel Turbo Boost Technology. See www.intel.com/technology/turboboost for more information.

2. Intel® Hyper-Threading Technology requires a computer system with a processor supporting HT Technology and an HT Technology-enabled chipset, BIOS, and operating system. Performance will vary depending on the specific hardware and software you use. For more information including details on which processors support HT Technology, see www.intel.com/info/hyperthreading.



DP67DE





Processor Support(H2) LGA 1155, 95W FMB	 Supports the Intel® Core™ i7, Intel® Core™ i5 and Intel® Core™ i3 processors in the LGA1155 package Supports Intel® Turbo Boost Technology Supports Intel® Hyper-Threading Technology
Chipset	 Intel® P67 Express Chipset Intel® Rapid Storage Technology, supports RAID 0,1,5,10
Метогу	Dual channel DDR3 1333/1066 MHzXMP Supports overclocking beyond 13334 DIMMs, 32 GB maximum
Graphics	■ 1 PCI Express*2.0 x16 Graphics Slot
Expandability	 4 SATA ports (3.0 Gb/s, 2 ports compatible with eSATA for back panel extension, one external eSATA port) 2 SATA port (6.0 Gb/s) 2 IEEE 1394a ports (1 external port, 1 via internal header) 2 PCIe x1 10 USB 2.0 ports (6 external ports, 8 via internal headers) 2 USB 3.0 back panel ports
Audio	 5 stack analog audio ports Rear optical S/PDIF out port and SPDIF out header Front panel mic/headphone header
Connectivity	■ Intel® 10 / 100 / 1000 Network Connection
Additional Features	Windows Vista Premium WHQL certifiedConsumer Infrared receiver and emitter (Vista* MCE compliant)
Customer Transition	DP55WB
Form Factor	■ Micro-ATX (9.6" x 9.6")





DH67CF



Processor Support(H2) LGA 1155, 95W FMB	 Supports the Intel® Core™ i7, Intel® Core™ i5 and Intel® Core™ i3 processors in the LGA1155 package Supports Intel® Turbo Boost Technology Supports Intel® Hyper-Threading Technology
Chipset	 Intel® H67 Express Chipset Intel® Rapid Storage Technology, supports RAID 0,1,5,10
Memory	 Dual channel DDR3 1333/1066 MHz 2 DIMMs, 16 GB maximum 1.2V-1.8V Memory voltage control for maximum DIMM compatibility
Graphics	1 PCI Express*2.0 x16 Graphics SlotDVI-I+ HDMI+ DisplayPort (DP) display output
Expandability	 3 SATA ports (3.0 Gb/s, 2 internal port with 1 compatible with eSATA for back panel extension, 1 eSATA external port) 2 SATA port (6.0 Gb/s) 10 USB 2.0 ports (4 external ports, 6 via internal headers) 2 USB 3.0 back panel ports
Audio	 10 (7.1+2) channel Intel® High Definition Audio 5 stack analog audio ports Rear optical S/PDIF out port and SPDIF out header Front panel mic/headphone header Internal speaker header
Connectivity	■ Intel® PRO 10/100/1000 integrated NIC
Additional Features	 Windows Vista* Premium WHQL certified Windows 7 WHQL certified Consumer Infrared receiver and emitter
Form Factor	■ Mini-ITX (6.7" x 6.7")

^{1.} Intel® Turbo Boost Technology requires a PC with a processor with Intel Turbo Boost Technology capability. Intel Turbo Boost Technology performance varies depending on hardware, software, and overall system configuration. Check with your PC manufacturer on whether your system delivers Intel Turbo Boost Technology. See www.intel.com/technology/turboboost for more information.

2. Intel® Hyper-Threading Technology requires a computer system with a processor supporting HT Technology and an HT Technology-enabled chipset, BIOS, and operating system. Performance will vary depending on the specific hardware and software you use. For more information including details on which processors support HT Technology, see www.intel.com/info/hyperthreading.



DH67BL



Processor Support(H2) LGA 1155,95W FMB	 Supports the Intel® Core™ i7, Intel® Core™ i5 and Intel® Core™ i3 processors in the LGA1155 package Supports Intel® Turbo Boost Technologyπ Supports Intel® Hyper-Threading Technology
Chipset	 Intel® H67 Express Chipset Intel® Rapid Storage Technology, supports RAID 0,1,5,10
Memory	 Dual channel DDR3 1333/1066 MHz 4 DIMMs, 16 GB maximum 1.2V-1.8V Memory voltage control for maximum DIMM compatibility
Graphics	1 PCI Express*2.0 x16 Graphics SlotDVI-I+HDMI display output
Expandability	 3 SATA ports (3.0 Gb/s, 1 port is compatible with eSATA for back panel extension) 2 SATA port (6.0 Gb/s) 1 eSATA back panel port(3.0 Gb/s) 2 USB 3.0 back panel ports 14 USB 2.0 ports (6 external ports, 8 via internal headers) 2 PCI Express*2.0 x1 slots 1 PCI slot
Audio	 10 (7.1+2) channel Intel® High Definition Audio 5 stack analog audio ports Rear optical S/PDIF out port and SPDIF out header Front panel mic/headphone header Internal speaker header
Connectivity	■ Intel® PRO 10/100/1000 integrated NIC
Additional Features	 Windows Vista* Premium WHQL certified Windows 7 WHQL certified Consumer Infrared receiver and emitter
Form Factor	■ MicroATX (9.6" x 9.6")

^{1.} Intel® Turbo Boost Technology requires a PC with a processor with Intel Turbo Boost Technology capability. Intel Turbo Boost Technology performance varies depending on hardware, software, and overall system configuration. Check with your PC manufacturer on whether your system delivers Intel Turbo Boost Technology. See www.intel.com/technology/turboboost for more information.

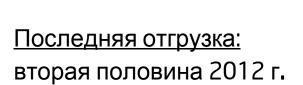
2. Intel® Hyper-Threading Technology requires a computer system with a processor supporting HT Technology and an HT Technology, enabled chipset, BIOS, and operating system. Performance will vary depending on the specific hardware and software you use. For more information including details on which processors support HT Technology, see www.intel.com/info/hyperthreading.



DH67VR







Processor Support(H2) LGA 1155	 Supports the Intel® Core™ i7, Intel® Core™ i5 and Intel® Core™ i3 processors in the LGA1155 package Supports Intel® Turbo Boost Technologyπ Supports Intel® Hyper-Threading Technology
Chipset	 Intel® H67 Express Chipset Intel® Rapid Storage Technology, supports RAID 0,1
Memory	 Dual channel DDR3 1333/1066 MHz 4 DIMMs, 32 GB maximum 1.2V-1.8V Memory voltage control for maximum DIMM compatibility
Graphics	 1 PCI Express*2.0 x16 Graphics Slot DVI-I+HDMI display output, supports dual independent display
Expandability	 2 SATA 6.0 Gb/s ports 2 SuperSpeed USB 3.0 back panel ports, 5Gb/s link speed 12 USB 2.0 ports (4 external ports, 8 via internal headers) 2 PCI Express*2.0 x1 slots 1 PCI slot
Audio	 10 (7.1+2) channel Intel® High Definition Audio with multi-streaming capability 5 stack analog audio ports Rear optical S/PDIF out port and SPDIF out header Front panel mic/headphone header Internal speaker header
Connectivity	■ Intel® PRO 10/100/1000 integrated NIC
Additional Features	 Windows Vista* Premium WHQL certified Windows 7 WHQL certified Consumer Infrared receiver and emitter
Form Factor	■ MicroATX (9.6" x 9.6")

^{1.} Intel® Turbo Boost Technology requires a PC with a processor with Intel Turbo Boost Technology capability. Intel Turbo Boost Technology performance varies depending on hardware, software, and overall system configuration. Check with your PC manufacturer on whether your system delivers Intel Turbo Boost Technology. See www.intel.com/technology/turboboost for more information.

2. Intel® Hyper-Threading Technology requires a computer system with a processor supporting HT Technology and an HT Technology-enabled chipset, BIOS, and operating system. Performance will vary depending on the specific hardware and software you use. For more information including details on which processors support HT Technology, see www.intel.com/info/hyperthreading.



DB65AL





Processor Support(H2) LGA 1155,95W FMB	 Supports the Intel® Core™ i7, Intel® Core™ i5 and Intel® Core™ i3 processors in the LGA1155 package Supports Intel® Turbo Boost Technologyπ Supports Intel® Hyper-Threading Technology
Chipset	■ Intel® B65 Express Chipset
Memory	 Dual channel DDR3 1333/1066 MHz 4 DIMMs, 16 GB maximum 1.2V-1.8V Memory voltage control for maximum DIMM compatibility
Graphics	1 PCI Express*2.0 x16 Graphics SlotVGA+DVI-D display output
Expandability	 5 SATA ports (3.0 Gb/s, 2 ports are compatible with eSATA for back panel extension) 1 SATA port (6.0 Gb/s) 12 USB 2.0 ports (6 external ports, 6 via internal headers) 1 PCI Express*2.0 x1 slot 1 PCI Express*2.0 x4 slot 1 PCI slot
Legacy	1 PS/2 port (mouse and keyboard compatible)1 Serial Port Header
Audio	 8 (5.1+2) channel Intel[®] High Definition Audio 3 stack analog audio ports S/PDIF out header on board Front panel mic/headphone header Internal speaker header
Connectivity	■ Intel® PRO 10/100/1000 integrated NIC
Additional Features	Windows 7 WHQL certifiedUpgradeable to standard manageability
Form Factor	■ MicroATX (9.6" x 9.6")





DQ67SW

Плата с поддержкой Intel® vPro™





Processor Support (H2) LGA 1155, 95W FMB Chipset	 Supports the Intel® Core™ i7, Intel® Core™ i5 and Intel®, Core™ i3 processors in the LGA1155 package Supports Intel® Turbo Boost Technology Supports Intel® Hyper-Threading Technology Intel® Q67 Express Chipset Intel® Rapid Storage Technology RAID 0,1,5,10 with Intel® Rapid Recover Technology & Matrix RAID
Метогу	 Dual channel DDR3 1333/1066 MHz 4 DIMMs, 32 GB maximum Supports memory Over Clocking, Over/Under Voltage
Graphics	One PCI Express*2.0 x16 Graphics Slot DisplayPort + DVI-I + DVI-D graphics output
Expandability	 Four onboard SATA ports (Two SATA 6.0 Gb/s; two SATA 3.0 Gb/s ports) Two eSATA 3.0 Gb/s on back panel Fourteen USB ports: Six back panel USB ports (Two USB 3.0; Four USB 2.0 ports) Eight ports via internal headers Two 1394 ports (One port on back panel; one via header) One PCI Express*2.0 x1 slot One PCI Express*2.0 x4 slot One PCI slot Legacy connectivity: Serial header
Audio	 8 (5.1+2) channel Intel* High Definition Audio with multistreaming support 3 stack analog audio ports S/PDIF out header on board Front panel mic/headphone header and Internal speaker header
Connectivity	■ Intel® Pro 10/100/1000 Network Connection
Additional Features	 Windows 7 WHQL certified, Windows Vista* Premium WHQL certified RedHat, Novell SLED Linux certified Intel* vPro™ Technology support: Intel* AMT 7.0 Professional Discrete Trusted Platform Module (TPM) Intel* Stable Image Platform Program (SIPP) & Extended Life Program (XLP)
Form Factor	■ MicroATX (9.6" x 9.6")



DQ670W

Плата с поддержкой Intel® vPго™





Processor Support (H2) LGA 1155, 95W FMB	 Supports the Intel® Core™ i7, Intel® Core™ i5 and Intel® LGA1155 package Supports Intel® Turbo Boost Technology Supports Intel® Hyper-Threading Technology
Chipset	 Intel® Q67 Express Chipset Intel® Rapid Storage Technology RAID 0,1,5,10 with Intel® Rapid Recover Technology & Matrix RAID
Memory	 Dual channel DDR3 1333/1066 MHz 4 DIMMs, 32 GB maximum Supports memory Over Clocking, Over/Under Voltage
Graphics	One PCI Express*2.0 x16 Graphics SlotVGA + DVI-D graphics output
Expandability	 Six onboard SATA ports (Two SATA 6.0 Gb/s; two SATA 3.0 Gb/s and two eSATA capable 3.0Gb/s ports) Fourteen USB 2.0 ports (Six back panel USB ports; eight ports via internal headers) One PCI Express*2.0 x1 slot One PCI Express*2.0 x4 slot One PCI slot Legacy connectivity: Serial header, parallel port, floppy header, PS/2 port
Audio	 8 (5.1+2) channel Intel® High Definition Audio with multistreaming support 3 stack analog audio ports S/PDIF out header on board Front panel mic/headphone header Internal speaker header
Connectivity	Intel* Pro 10/100/1000 Network Connection
Additional Features	 Windows 7 WHQL certified, Windows Vista* Premium WHQL certified RedHat, Novell SLED Linux certified Intel* vPro™ Technology support: Intel* AMT 7.0 Professional Discrete Trusted Platform Module Intel* Stable Image Platform Program (SIPP) & Extended Life Program (XLP)
Form Factor	• MicroATX (9.6" x 9.6")



DQ67EP

Плата с поддержкой Intel® vPro™





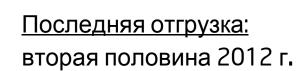
Processor Support (H2) LGA 1155,95W FMB	 Supports the Intel® Core™ i5 and Intel® Core™ i3 processors in the LGA1155 package Supports Intel® Turbo Boost Technology Supports Intel® Hyper-Threading Technology
Chipset	 Intel® Q67 Express Chipset Intel® Rapid Storage Technology RAID 0,1,5,10 with Intel® Rapid Recover Technology & Matrix RAID
Memory	 Dual channel DDR3 1333/1066 MHz 2 DIMMs, 16 GB maximum Supports memory Over Clocking, Over/Under Voltage
Graphics	 One PCI Express*2.0 x16 Graphics Slot DisplayPort + DVI-I + DVI-D graphics output
Expandability	 Four onboard SATA ports (Two SATA 6.0 Gb/s; Two SATA 3.0 Gb/s ports) Two eSATA 3.0 Gb/s on backpanel Twelve USB ports: Six back panel USB ports (Two USB 3.0; Four USB 2.0 ports) Six ports via internal headers One mini-PCle slot (half length support) Legacy connectivity: Serial header
Audio	 8 (5.1+2) channel Intel* High Definition Audio Audio with multistreaming support 3 stack analog audio ports S/PDIF out header on board Front panel mic/headphone header Internal speaker header
Connectivity	■ Intel® Pro 10/100/1000 Network Connection
Additional Features	 Windows 7 WHQL certified, Windows Vista* Premium WHQL certified RedHat, Novell SLED Linux certified Intel* vPro™ Technology support: Intel* AMT 7.0 Professional Discrete Trusted Platform Module Intel* Stable Image Platform Program (SIPP) & Extended Life Program (XLP)
Form Factor	- Mini-ITX (6.75" x 6.75")



^{*}доступна версия продукта с удлиненным циклом жизни, последняя отгрузка - вторая половина 2014 г.

DH61AG



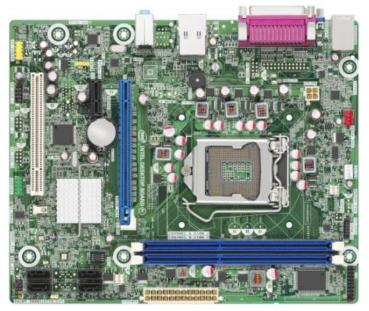


*доступна версия продукта с удлиненным циклом жизни, последняя отгрузка - вторая половина 2014 г.

Processor Support(Support for up to 65W FMB processors in the LGA1155 (H2) package: Intel® Core™ i5, Intel® Core™ i3 processors Intel® Xeon® E3-1200 family processors Intel® Pentium™ processors Intel® Celeron® processors
Chipset	Intel® H61 Express Chipset
Метогу	 Dual channel DDR3 1333/1066 MHz 2 SO-DIMMs, 16 GB maximum
Graphics	 DVI-I+ HDMI display output eDP/LVDS (24bpp/dual channel) headers with diverse panel support
Expandability	 2 PCle mini-card connectors (one half-length, one full-/half-length) 2 SATA ports (3.0 Gb/s) 1 backpanel eSATA port mSATA support (via FMC connector) ExpressCard/34 support (via 3rd party adapter on FMC connector) 2 Backpanel USB 3.0 ports, 2 USB 2.0 ports with high-current support 8 Internal USB 2.0 ports (5 via headers, 1 via HMC, 2 via FMC) PCle x4 slot
Audio	 7.1+2 channel Intel® High Definition Audio Backpanel analog/digital line-out and analog line-in Digital audio header (2nd SPDIF out) Internal stereo speakers header (3W/4ohms) Analog surround audio header Front panel mic/headphone header
Connectivity	■ Intel® PRO 10/100/1000 integrated NIC
Additional Features	 Windows 7 WHQL certified Consumer IR receiver header HTPC header (incl. Recording LED, HDMI CEC access and more) Trusted Platform Module (option) backpanel DC input (19V)
Form Factor	■ 20 mm Thin Mini-ITX (6.7" x 6.7" compliant footprint)



DH61WW





Processor	 Supports the Intel® Core™ i7 and Intel® Core™ i5, Intel® Core™ i3, Pentium® and Celeron® processors in the LGA1155 package Supports Intel® Turbo Boost Technology Supports Intel® Hyper-Threading Technology Supports Intel® Virtualization Technology (Intel® VT) with select Intel® processors that feature Intel® VT
Chipset	Intel® H61 Express Chipset
Memory	Dual Channel DDR3 1600(OC)/1333/1066 MHz2 DIMM, 8GB maximum
Graphics	Integrated VGA port1 PCIe x16 slot
Expandability	 4 SATA 2.0 ports (3 Gb/s) 6 USB 2.0 ports (4 external ports, 2 via internal headers) 1 PCI Conventional slot 1 PCI Express x1 slot Legacy I/O: 1 PS/2 Port (keyboard or mouse) 1 Serial Header 1 Parallel Port
Audio	 Intel® High Definition Audio (Intel® HD Audio) subsystem in 6-channel (5.1) audio subsystem configuration Front panel mic/headphone header S/PDIF Out Audio Header
Connectivity	Intel® Gigabit Ethernet Controller
Additional Comments	Windows Vista* Premium WHQL certifiedWindows 7 WHQL certified
Form Factor	• uATX (9.6" x 7.8")



DH61CR





Processor	 Supports the Intel® Core™ i7 and Intel® Core™ i5, Intel® Core™ i3, Pentium® and Celeron® processors in the LGA1155 package Supports Intel® Turbo Boost Technology Supports Intel® Hyper-Threading Technology Supports Intel® Virtualization Technology (Intel® VT) with select Intel® processors that feature Intel® VT
Chipset	Intel® H61 Express Chipset
Memory	Dual Channel DDR3 1600(OC)/1333/1066 MHz2 DIMM, 8GB maximum
Graphics	Integrated VGA & DVI ports1 PCIe x16 slot
Expandability	 4 SATA 2.0 ports (3 Gb/s) 10 USB 2.0 ports (4 external ports, 6 via internal headers) 1 PCI Conventional slot 2 PCI Express x1 slot Legacy I/O: 1 PS/2 Port (keyboard or mouse) 1 Serial Header 1 Parallel Port
Audio	 Intel® High Definition Audio (Intel® HD Audio) subsystem in 6-channel (5.1) audio subsystem configuration Front panel mic/headphone header S/PDIF Out Audio Header
Connectivity	Intel® Gigabit Ethernet Controller
Additional Comments	Windows Vista* Premium WHQL certifiedWindows 7 WHQL certified
Form Factor	• uATX (9.6" x 7.8")



DH61BE





Processor	 Supports the Intel® Core™ i7 and Intel® Core™ i5, Intel® Core™ i3, Pentium® and Celeron® processors in the LGA1155 package Supports Intel® Turbo Boost Technology Supports Intel® Hyper-Threading Technology Supports Intel® Virtualization Technology (Intel® VT) with select Intel® processors that feature Intel® VT
Chipset	Intel® H61 Express Chipset
Memory	Dual Channel DDR3 1600(OC)/1333/1066 MHz2 DIMM, 8GB maximum
Graphics	Integrated VGA & DVI ports 1 PCIe x16 slot
Expandability	 4 SATA 2.0 ports (3 Gb/s) 2 SATA 3.0 ports (6Gb/s) 10 USB 2.0 ports (2 external ports, 8 via internal headers) 2 USB 3.0 ports 1 PCI Conventional slot 2 PCI Express x1 slots Legacy I/O: 1 PS/2 Port (keyboard or mouse) 1 Serial Header 1 Parallel Port
Audio	 Intel® High Definition Audio (Intel® HD Audio) subsystem in 8-channel (7.1) audio subsystem configuration Front panel mic/headphone header S/PDIF Out Audio Header
Connectivity	Intel® Gigabit Ethernet Controller
Additional Comments	Windows Vista* Premium WHQL certifiedWindows 7 WHQL certified
Form Factor	• uATX (9.6" x 7.8")



DH61DL





Processor Chipset	 Supports the Intel® Core™ i7 and Intel® Core™ i5, Intel® Core™ i3, Pentium® and Celeron® processors in the LGA1155 package Supports Intel® Turbo Boost Technology Supports Intel® Hyper-Threading Technology Supports Intel® Virtualization Technology (Intel® VT) with select Intel® processors that feature Intel® VT Intel® H61 Express Chipset
Memory	Dual Channel DDR3 1600(OC)/1333/1066 MHz2 DIMM, 8GB maximum
Graphics	Integrated VGA & DVI ports
Expandability	 3 SATA 2.0 ports (3 Gb/s) 8 USB 2.0 ports (2 external ports, 6 via internal headers) 2 USB 3.0 ports (2 external ports) 1 PCI Express x1 slot 1 PCI Express Mini-card slot Legacy I/O: 1 PS/2 Port (keyboard or mouse) 1 Serial Header 1 Parallel Port
Audio	 Intel® High Definition Audio (Intel® HD Audio) subsystem in 6-channel (5.1) audio subsystem configuration Front panel mic/headphone header S/PDIF Out Audio Header
Connectivity	Intel® Gigabit Ethernet Controller
Additional Comments	Windows Vista* Premium WHQL certifiedWindows 7 WHQL certified
Form Factor	• Mini-ITX (6.7" x 6.7")



D525MW





Последняя отгрузка: первая половина 2013 г.

*доступна версия продукта с удлиненным циклом жизни, последняя отгрузка - первая половина 2014 г.

Processor (Soldered Down)	 Intel® Atom™ Processor D525 (Dual Core) 1.8GHz / 512KB X2 L2 cache
Chipset	■ Intel NM10 Express Chipset
Memory	 Single channel SODIMM DDR3 1066¹/800 MHz 2 SODIMM, 4GB maximum
Graphics	 Integrated graphic VGA port & on board LVDS (optional and available on BLK/LAD525MWV)
Expandability	 2 SATA II ports (3 Gb/s) 8 USB 2.0 ports (4 external ports, 2 via headers, 1 USB for PCIe Mini Card & 1 USB for flash card/SSD) 1 PCI & PCIe mini slot Legacy I/O: PS/2 1 Serial headers / 1 serial port Parallel port
Audio	6 Channel HD Audio (with multi streaming support)Front panel mic/headphone headerSPDIF header
Connectivity	Integrated 10/100/1000 Ethernet ControllerWireless option via PCIe Mini Card
Additional Comments	 Windows Vista* Basic WHQL certified Windows 7* Starter / Home Basic support
Customer Transition	■ Follow on to D510MO
Form Factor	 mini ITX (170mm X 170mm) / uATX compatible Passive thermal solution; Z-height ~35mm

Note #1: 1066MHz memory DIMM will down-clock to 800MHz.



D425KT



BOX/BLK/LAD410PT Back Panel



<u>Последняя отгрузка:</u> вторая половина 2012 г.

^{*}доступна версия продукта с удлиненным циклом жизни, последняя отгрузка - первая половина 2014 г.

Processor (Soldered Down)	 Intel® Atom™ Processor D425 (Single Core) 1.8GHz / 512KB L2 cache
Chipset	■ Intel NM10 Express Chipset
Memory	 Single channel SODIMM DDR3 1066¹/800 MHz 2 SODIMM, 4GB maximum
Graphics	 Integrated graphic VGA port & on board LVDS (optional and available on LAD425KTW)
Expandability	 2 SATA II ports (3 Gb/s) 8 USB 2.0 ports (4 external ports, 4 via headers) 1 PCI Legacy I/O: PS/2 1 Serial headers / 1 serial port Parallel port LAD425KTW: all feature set same as D410PTL except for 3 USB port support internally + PCIe mini card + LVDS)
Audio	2+2 Channel HD Audio (with multi streaming support)Front panel mic/headphone header
Connectivity	■ Integrated 10/100 Ethernet Controller
Additional Comments	Windows vista* Basic WHQL certifiedWindows 7* Starter / Home Basic support
Customer Transition	■ Follow on to D410PT
Form Factor	 mini ITX (170mm X 170mm) / uATX compatible Passive thermal solution; Z-height ~35mm

Note #1: 1066MHz memory DIMM will down-clock to 800MHz.

